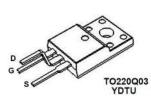


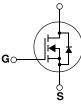
FQPF2N80YDTU N-Channel QFET[®] MOSFET 800 V, 1.5 A, 6.3 Ω

Description

This N-Channel enhancement mode power MOSFET is \bullet 1.5 A, 800 V, R_{DS(on)}=6.3 Ω (Max.)@V_{GS}=10 V, I_D=0.75 A produced using Fairchild Semiconductor®'s proprietary Low Gate Charge (Typ. 12 nC) planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to $\ \cdot \ \text{Low} \ \text{C}_{\text{rss}} \ (\text{Typ. 5.5 pF})$ reduce on-state resistance, and to provide superior • 100% Avalanche Tested switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features





D

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

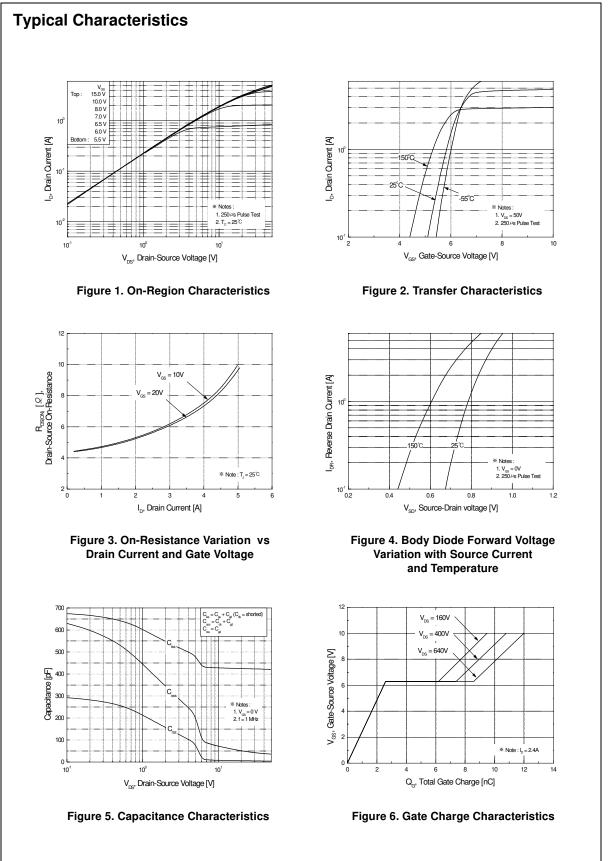
Symbol	Parameter		FQPF2N80YDTU	Unit
V _{DSS}	Drain-Source Voltage		800	V
I _D	Drain Current - Continuous (T _C = 25°	C)	1.5	Α
- Continuous (T _C = 100°C))°C)	0.95	A
I _{DM}	Drain Current - Pulsed	(Note 1)	6.0	Α
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	5.2	mJ
I _{AR}	Avalanche Current	(Note 1)	1.5	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	3.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.0	V/ns
PD	Power Dissipation ($T_C = 25^{\circ}C$)		35	W
	- Derate above 25°C		0.28	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

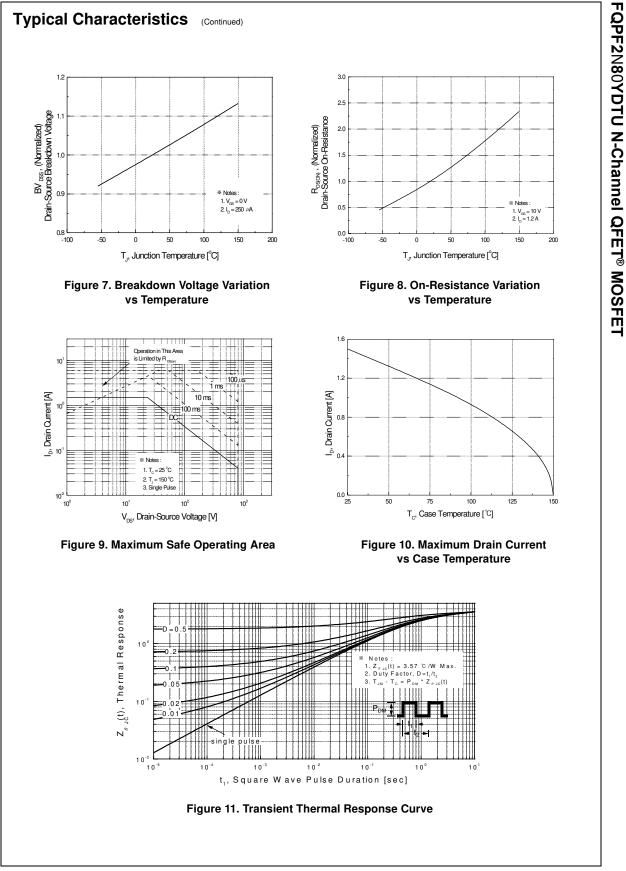
Symbol	Parameter	FQPF2N80YDTU	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	3.57	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

July 2013

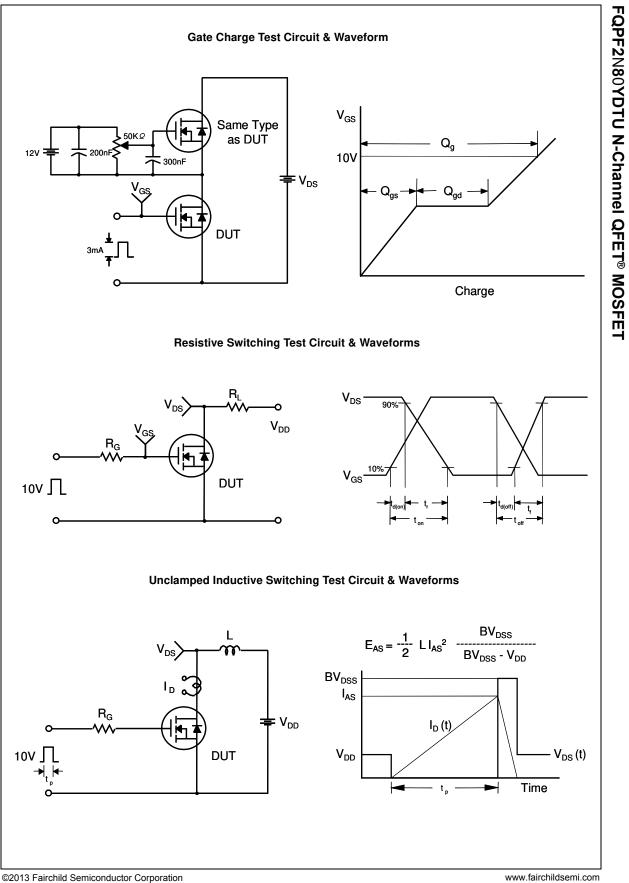
	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA				V
ΔBV _{DSS} / ΔT _{.1}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		0.9		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 800 V, V _{GS} = 0 V			10	μA
		V _{DS} = 640 V, T _C = 125°C			100	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$		1	-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	3.0		5.0	V
R _{DS(on)}	Static Drain-Source		0.0			-
D3(01)	On-Resistance $V_{GS} = 10 \text{ V}, I_D = 0.75 \text{ A}$			4.9	6.3	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 0.75 \text{ A}$		2.2		S
Dunom	in Characteristics					
C _{iss}	ic Characteristics	N 05 Y Y 0 Y		425	550	pF
C _{oss}	Output Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz		45	60	pr
C _{rss}	Reverse Transfer Capacitance	T = 1.0 MHZ		5.5	7.0	pr
d(on)	ng Characteristics Turn-On Delay Time Turn-On Delay Time	V _{DD} = 400 V, I _D = 2.4 A,		12	35	ns
t _r	Turn-On Rise Time	R _G = 25 Ω		30	70	ns
t _{d(off)}	Turn-Off Delay Time	(Note 4)		25	60	ns
t _f	Turn-Off Fall Time			28	65	ns
()	Total Gate Charge	$V_{DS} = 640 \text{ V}, I_{D} = 2.4 \text{ A},$		12	15	nC
*	Gate-Source Charge	V _{GS} = 10 V		2.6		nC
Q _{gs}				6.0		nC
Q _g Q _{gs} Q _{gd}	Gate-Drain Charge	(Note 4)				
Q _{gs} Q _{gd}	Gate-Drain Charge	, , , , , , , , , , , , , , , , , , ,				
Q _{gs} Q _{gd} Drain-S	-	nd Maximum Ratings			1.5	A
Q _{gs} Q _{gd} Drain-S	ource Diode Characteristics a	nd Maximum Ratings			1.5 6.0	A
Q _{gs} Q _{gd}	ource Diode Characteristics an Maximum Continuous Drain-Source Dic	nd Maximum Ratings bde Forward Current Forward Current $V_{GS} = 0 V, I_S = 1.5 A$				
Q _{gs} Q _{gd} Drain-S Is IsM	Maximum Continuous Drain-Source Diode F Maximum Pulsed Drain-Source Diode F	nd Maximum Ratings ode Forward Current Forward Current			6.0	Α



FQPF2N80YDTU N-Channel QFET® MOSFET

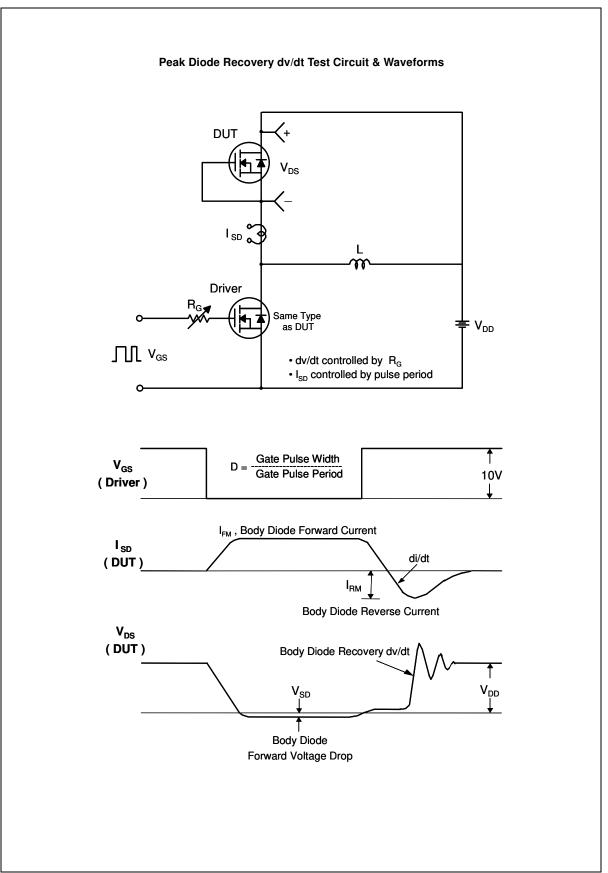


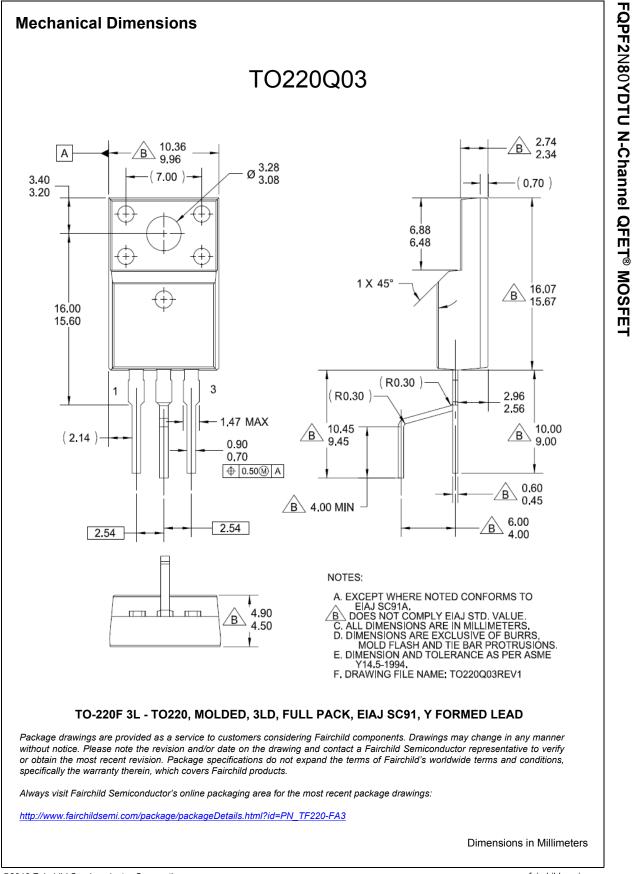
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FQPF2N80YDTU Rev. C1

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